



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **TANIGUCHI, et al.**

Serial No.: **09/836,182**

Filed: **April 18, 2001**

Group Art Unit: **2827** *Amold*

Examiner: **MITCHELL, James M.** *J. Mcmillan*

P.T.O. Confirmation No.: **7961** *7/23/02*

FOR: **METHOD OF FABRICATING SEMICONDUCTOR HAVING THROUGH HOLE**

**AMENDMENT UNDER 37 CFR §1.111**

Commissioner for Patents  
Washington, D.C. 20231

July 17, 2002

Sir:

In response to the Office Action dated **April 19, 2002**, please amend the above-identified application as follows:

**IN THE SPECIFICATION:**

Please amend the paragraph beginning at line 11 on page 15, to read as follows:

Sample No. 5 is the TAB tape 14 made of Kapton Type 200EN from Toray•Dupont Corporation. The water permeability of sample No. 5 is 14.5, which is 10 times as high as that of the comparative sample 2. Same No. 6 in Table 3 below is the TAB tape 14 using Kapton Type 200V. This material has water permeability of 37.3 (25 times as high as that of the comparative sample).

*DI*